

## Part Number: XZMOK81FS

2.8X0.8mm RIGHT ANGLE SMD CHIP LED LAMP

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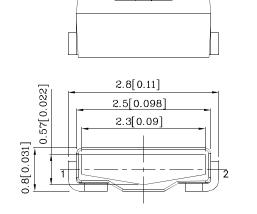
### Features

- Ideal for indication light on hand held products
- Long life and robust package
- Standard Package: 2,000pcs/ Reel
- MSL (Moisture Sensitivity Level): 3
- $\bullet$  RoHS compliant

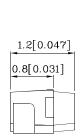




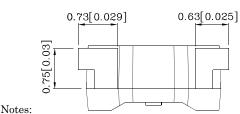
ATTENTION OBSERVE PRECAUTIONS FOR HANDLING ELECTROSTATIC DISCHARGE SENSITIVE DEVICES



**Package Schematics** 



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1. All dimensions are in millimeters (inches).

2. Tolerance is  $\pm 0.1(0.0039")$  unless otherwise noted.

3. Specifications are subject to change without notice.

Absolute Maximum Ratings (T <sub>A</sub> =25°C)		Orange (AlGaInP)	Unit	
Reverse Voltage	$V_{R}$	5	V	
Forward Current	$\mathbf{I}_{\mathrm{F}}$	30	mA	
Forward Current (Peak) 1/10 Duty Cycle 0.1ms Pulse Width	ifs	195	mA	
Power Dissipation	$\mathbf{P}_{\mathrm{D}}$	75	mW	
Operating Temperature	$T_{\rm A}$	$-40 \sim +85$	°C	
Storage Temperature	Tstg	$-40 \sim +85$	-0	

A Relative Humidity between 40% and 60% is recommended in ESD-protected work areas to reduce static build up during assembly process (Reference JEDEC/JESD625-A and JEDEC/J-STD-033)

<b>Operating Characteristics</b>		Orange	Unit	
(T <sub>A</sub> =25°C)		(AlGaInP)	Unit	
Forward Voltage (Typ.) (I <sub>F</sub> =20mA)	$V_{\rm F}$	2.1	V	
Forward Voltage (Max.) (I <sub>F</sub> =20mA)	$V_{\mathrm{F}}$	2.5	V	
Reverse Current (Max.) (V <sub>R</sub> =5V)	$I_R$	10	uA	
Wavelength of Peak Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λP	610*	nm	
Wavelength of Dominant Emission CIE127-2007* (Typ.) (I <sub>F</sub> =20mA)	λD	601*	nm	
Spectral Line Full Width At Half-Maximum (Typ.) (I <sub>F</sub> =20mA)	$ riangle\lambda$	29	nm	
Capacitance (Typ.) (V <sub>F</sub> =0V, f=1MHz)	С	15	$_{ m pF}$	

Part Number	Emitting Color	Emitting Material	Lens-color	CIE127 (I <sub>F</sub> =2	s Intensity 7-2007* 0mA) cd	Wavelength CIE127-2007* λΡ nm	Viewing Angle 20 1/2
				min.	typ.		
XZMOK81FS	Orange	AlGaInP	Water Clear	150 120*	248 248*	610*	110°

\*Luminous intensity value and wavelength are in accordance with CIE127-2007 standards.

Sep 28,2016

XDSB3985 V4-X Layout: Maggie L.



### **Handling Precautions**

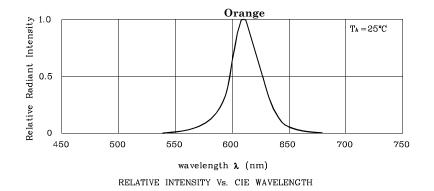
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products. Failure to comply might lead to damage and premature failure of the LED.

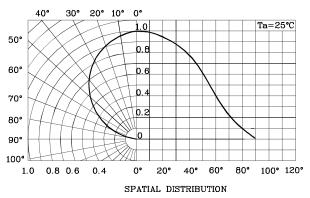
1.Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry.



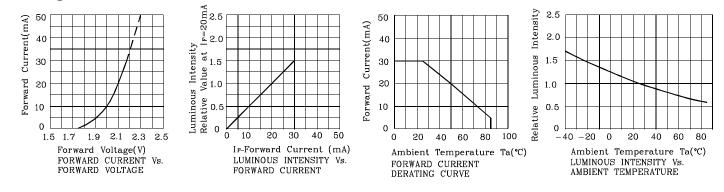
 $2. \ As \ silicone \ encapsulation \ is \ permeable \ to \ gases, \ some \ corrosive \ substances \ such \ as \ H_2S \ might \ corrode \ silver \ plating \ of \ leadframe. \ Special \ care \ should \ be \ taken \ if \ an \ LED \ with \ silicone \ encapsulation \ is \ to \ be \ used \ near \ substances.$ 



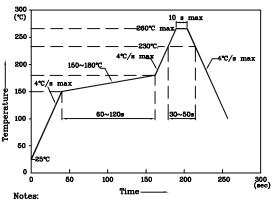




### ♦ Orange



# LED is recommended for reflow soldering and soldering profile is shown below.



Reflow Soldering Profile for SMD Products (Pb-Free Components)

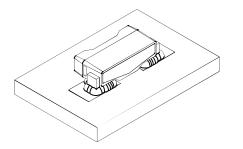
1. Maximum soldering temperature should not exceed 260°C

2. Recommended reflow temperature: 145°C-260°C 3. Do not put stress to the epoxy resin during

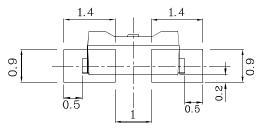
high temperatures conditions



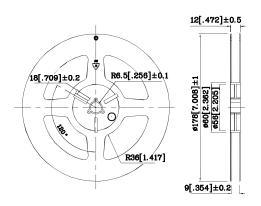
✤ The device has a single mounting surface. The device must be mounted according to the specifications.



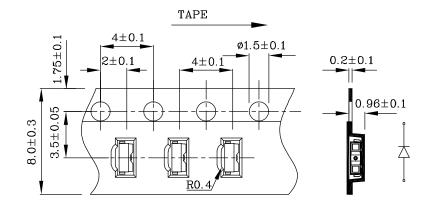
Recommended Soldering Pattern (Units : mm; Tolerance: ± 0.1)



Reel Dimension



## Tape Specification (Units : mm)



Remarks:

If special sorting is required (e.g. binning based on forward voltage, Luminous intensity / luminous flux, or wavelength), the typical accuracy of the sorting process is as follows:

1. Wavelength: +/-1nm

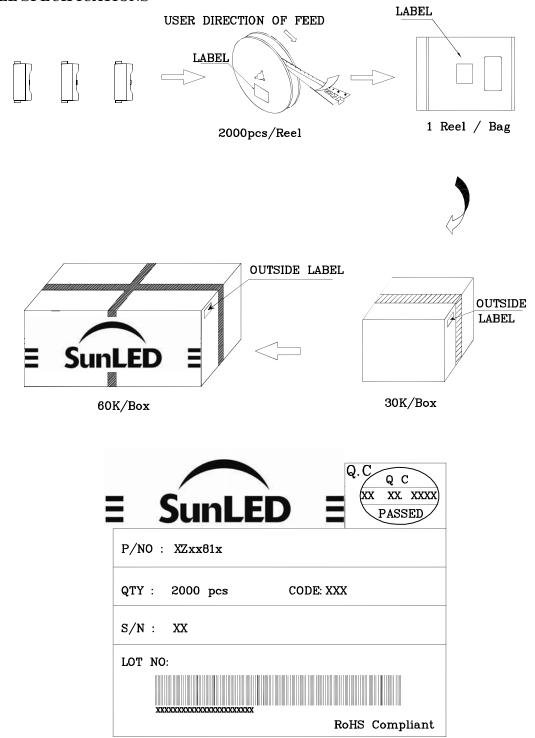
2. Luminous intensity / luminous flux: +/-15%

3. Forward Voltage: +/-0.1V  $\,$ 

Note: Accuracy may depend on the sorting parameters.



### **PACKING & LABEL SPECIFICATIONS**



#### TERMS OF USE

- 1. Data presented in this document reflect statistical figures and should be treated as technical reference only.
- 2. Contents within this document are subject to improvement and enhancement changes without notice.
- 3. The product(s) in this document are designed to be operated within the electrical and environmental specifications indicated on the datasheet.
- User accepts full risk and responsibility when operating the product(s) beyond their intended specifications. 4. The product(s) described in this document are intended for electronic applications in which a person's life is not reliant upon the LED. Please
- consult with a SunLED representative for special applications where the LED may have a direct impact on a person's life.
- 5. The contents within this document may not be altered without prior consent by SunLED.
- $6. \ Additional \ technical \ notes \ are \ available \ at \ \underline{http://www.SunLEDusa.com/TechnicalNotes.asp}$